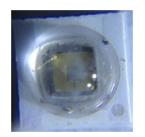
Specification

Client Name:	
Client P/N:	OF-SMD3535UV-C
Product P/N:	
Sending Date:	



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



Features

Dimension: 3.45mm×3.45mm×1.9mm

Viewing angle 120°

RoHS compliant

Anti-vulcanization

Reflow Solder-able

Applications

Fluorescent spectroscopy

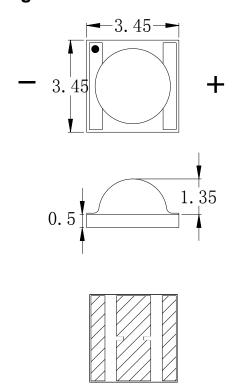
Sensors and monitors

Bio-analysis/detection

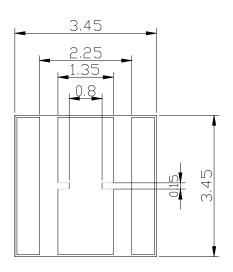
Phototherapy

Disinfection

Package Dimensions:



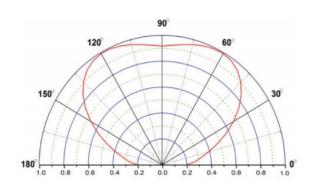
Recommended Soldering



Notes

- 1. All dimension units are millimeters.
- 2. All dimension tolerance is ±0.2mm unless otherwise noted.

Radiation Pattern



Typical Optical/ Electrical Characteristics @ T_a =25°C

Parameters 参数	Symbol 符号	Forward Current IF	Min.	Тур.	Max.	Unit
Forward Voltage 正向电压	VF	@20mA	5	6.6	ı	V
Optical Power 光功率	P _{out}	@20mA	0.2	0.35	0.5	mW
Peak Wavelength 峰值波长	λр	@20mA	260	265	270	_
FWHM 半峰宽	_	@20mA	9	10	_	nm
Lifetime 寿命	L(50)	@20mA	200	216	250	Hour

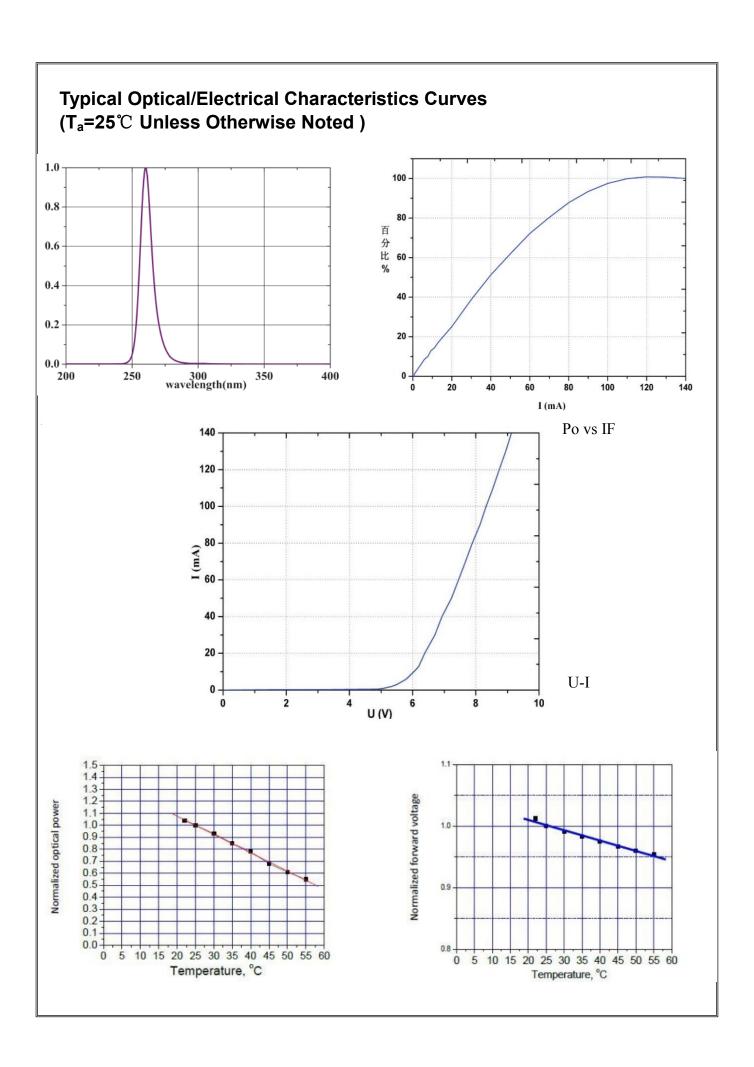
Notes

1.Tolerance of measurement of forward voltage±0.1V \ peak Wavelength±2.0nm \ luminous power±5%

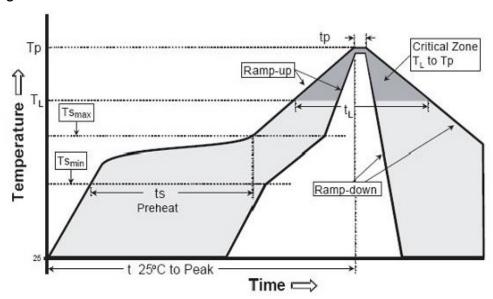
Absolute Maximum Ratings

Parameter参数	Symbol	Rating Value	Units	
Input power 输入功率	Pi	0.12	W	
Maximum operating current 最大工作电流	IF _{max}	20	mA	
Junction Temperature结温	Tj	115	°C	
Operating Temperature Range工作温度	Тор	-20°C To +45°C		
Storage Temperature Range储藏温度	Tstg	-40°C To +80°C		
Lead Soldering Temperature*引线焊接温度	T _{SOL}	Max. 350℃ for 5sec Max.		

Note:



Soldering



Reflow soldering

Caution

- 1.wave peak and soak-stannum soldering etc.is not suitable for this products.
- 2.reflow solding should not be done more than one time
- 3. The peak reflow temperature is 180 +10 °C, not more than 40 seconds
- 4.Repairing should not be done after the LEDs have been soldered. When repairing is un avoidable, suitable tools have to be used.
- 5.when solding, do not put stress on the LEDs during heating.
- 6.After soldering, do not warp the LED.do not stack PCBS or assemblies cantaing K Series LEDS so that anything rests on the LED lens.

Test

1.All Deep UV LED products mounted on aluminum metal-core printed circuit board, can be lighted directly, but we do not recommend lighting the Deep UV LED products for more than 5 seconds without a appropriate heat dissipation equipment.

Label

RoHS

TYPE:

QTY:

VF:

IF:

λp:

P_{out}:

DATE:

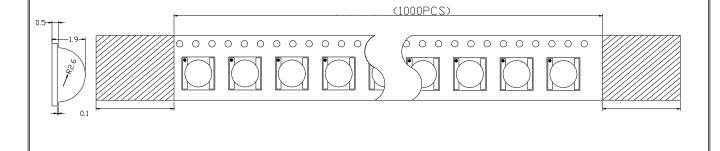
LOT.NO:

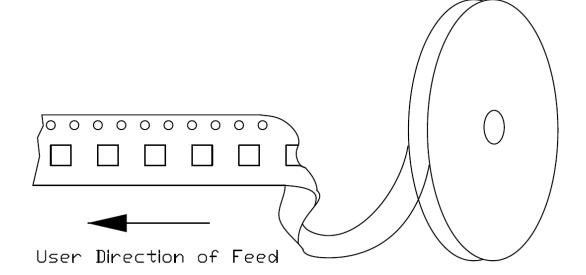
 \mathbf{P}_{out} : Optical Power

VF: Forward voltage rank

λp: Peak Wavelength

Tape Specifications(Units:mm)

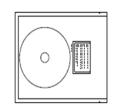




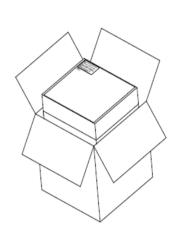
Packing[,]







1Reel/ESD Shieding Bag

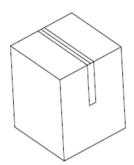






5InnerBox/OuterBox: 25000pcs 5Bags/InnerBox: 5000pcs





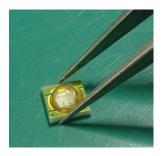
Outer Box: 25000pcs

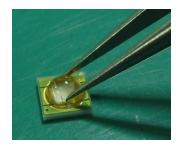
Precaution for use

1.Storage

To avoid the moisture penetration ,we recommend storing LEDs in a dry box (or a desiccator) with a desiccant. The recommended conditions are temperature 5 to 30 degrees Centigrade. Humidity 60% maximum.

- 2. Precaution after opening packing
 - 2.1. Soldering should be done right after opening the package (within 24Hrs).
 - 2.2. Keeping of a fraction.
 - -Sealing
 - -Temperature: 5~30°C
- ; Humidity: less than 30%
- 2.3.If the package has been opened than 1 week or the color of desiccant changed, components should be dried for 10-12 Hrs at $60\pm5^{\circ}$ C
- 3. Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
 - 4. Please avoid rapid cooling after soldering.
 - 5. Components should not be mounted on warped direction of PCB.
- 6. This device should not be used in any fluid such as water, oil ,organic solvent etc. When washing is required, Isopropyl Alcohol should be used.
 - 7. Avoid touching Lens parts especially by sharp tools such as pincette.
- 8.Please do not force over 1000g impact or pressure diagonally on the silicone lens. It will cause fatal damage on this product.
 - 9.Please do not cover the silicone resin of the LEDs with other resin.
 - 10.Do not use metal suction nozzle, rubber or silica gel suction nozzle is recommended.





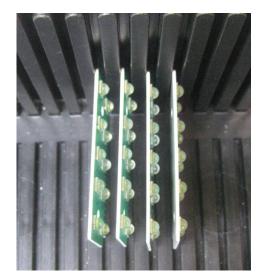
NG

OK

Note

- 1.2θ_{1/2}is the angle from optical centerline where the luminous power is 1/2 the optical centerline value.
- 3. The value only for reference.

13.Do not stack PCBs or assemblies containing the LEDs so that anything rests on the LED lens. Force applied to the LED lens may result in the lens being knocked off. PCBs or assemblies containing the LEDs should be stacked in a way to allow at least 2 cm clearance above the LED lens.





OK

OK



NG